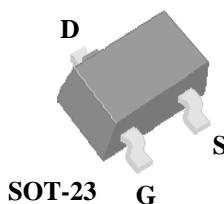


AP2302GN-HF

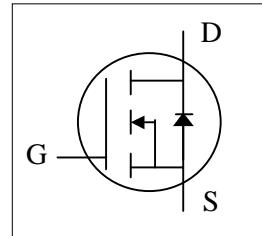
- ▼ Capable of 2.5V gate drive
- ▼ Small package outline
- ▼ Surface mount package
- ▼ RoHS Compliant



| | |
|--------------|------|
| BV_{DSS} | 20V |
| $R_{DS(ON)}$ | 85mΩ |
| I_D | 3.2A |

Description

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, low on-resistance and cost-effectiveness.



Absolute Maximum Ratings

| Symbol | Parameter | Rating | Units |
|--------------------------|---|------------|-------|
| V_{DS} | Drain-Source Voltage | 20 | V |
| V_{GS} | Gate-Source Voltage | ± 12 | V |
| $I_D @ T_A = 25^\circ C$ | Continuous Drain Current ³ , $V_{GS} @ 4.5V$ | 3.2 | A |
| $I_D @ T_A = 70^\circ C$ | Continuous Drain Current ³ , $V_{GS} @ 4.5V$ | 2.6 | A |
| I_{DM} | Pulsed Drain Current ¹ | 10 | A |
| $P_D @ T_A = 25^\circ C$ | Total Power Dissipation | 1.38 | W |
| | Linear Derating Factor | 0.01 | W/°C |
| T_{STG} | Storage Temperature Range | -55 to 150 | °C |
| T_J | Operating Junction Temperature Range | -55 to 150 | °C |

Thermal Data

| Symbol | Parameter | Value | Unit |
|-------------|---|-------|------|
| R_{thj-a} | Maximum Thermal Resistance, Junction-ambient ³ | 90 | °C/W |

AP2302GN-HF

Electrical Characteristics@ $T_j=25^\circ\text{C}$ (unless otherwise specified)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|--|---|---|------|------|-----------|---------------------------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=250\mu\text{A}$ | 20 | - | - | V |
| $\Delta \text{BV}_{\text{DSS}}/\Delta T_j$ | Breakdown Voltage Temperature Coefficient | Reference to 25°C , $I_{\text{D}}=1\text{mA}$ | - | 0.1 | - | $\text{V}/^\circ\text{C}$ |
| $R_{\text{DS(ON)}}$ | Static Drain-Source On-Resistance ² | $V_{\text{GS}}=4.5\text{V}$, $I_{\text{D}}=3.6\text{A}$ | - | - | 85 | $\text{m}\Omega$ |
| | | $V_{\text{GS}}=2.5\text{V}$, $I_{\text{D}}=3.1\text{A}$ | - | - | 115 | $\text{m}\Omega$ |
| $V_{\text{GS(th)}}$ | Gate Threshold Voltage | $V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=250\mu\text{A}$ | 0.5 | - | 1.2 | V |
| g_{fs} | Forward Transconductance | $V_{\text{DS}}=5\text{V}$, $I_{\text{D}}=3.6\text{A}$ | - | 6 | - | S |
| I_{DSS} | Drain-Source Leakage Current | $V_{\text{DS}}=20\text{V}$, $V_{\text{GS}}=0\text{V}$ | - | - | 1 | uA |
| | Drain-Source Leakage Current ($T_j=70^\circ\text{C}$) | $V_{\text{DS}}=20\text{V}$, $V_{\text{GS}}=0\text{V}$ | - | - | 10 | uA |
| I_{GSS} | Gate-Source Leakage | $V_{\text{GS}}=\pm 12\text{V}$, $V_{\text{DS}}=0\text{V}$ | - | - | ± 100 | nA |
| Q_g | Total Gate Charge ² | $I_{\text{D}}=3.6\text{A}$ | - | 4.4 | - | nC |
| Q_{gs} | Gate-Source Charge | $V_{\text{DS}}=10\text{V}$ | - | 0.6 | - | nC |
| Q_{gd} | Gate-Drain ("Miller") Charge | $V_{\text{GS}}=4.5\text{V}$ | - | 1.9 | - | nC |
| $t_{\text{d(on)}}$ | Turn-on Delay Time ² | $V_{\text{DS}}=10\text{V}$ | - | 5.2 | - | ns |
| t_r | Rise Time | $I_{\text{D}}=3.6\text{A}$ | - | 37 | - | ns |
| $t_{\text{d(off)}}$ | Turn-off Delay Time | $R_G=6\Omega$, $V_{\text{GS}}=5\text{V}$ | - | 15 | - | ns |
| t_f | Fall Time | $R_D=2.8\Omega$ | - | 5.7 | - | ns |
| C_{iss} | Input Capacitance | $V_{\text{GS}}=0\text{V}$ | - | 145 | - | pF |
| C_{oss} | Output Capacitance | $V_{\text{DS}}=10\text{V}$ | - | 100 | - | pF |
| C_{rss} | Reverse Transfer Capacitance | f=1.0MHz | - | 50 | - | pF |
| R_g | Gate Resistance | f=1.0MHz | - | 5.3 | 8 | Ω |

Source-Drain Diode

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|-----------------|---|---|------|------|------|-------|
| I_S | Continuous Source Current (Body Diode) | $V_D=V_G=0\text{V}$, $V_S=1.2\text{V}$ | - | - | 1 | A |
| I_{SM} | Pulsed Source Current (Body Diode) ¹ | | - | - | 10 | A |
| V_{SD} | Forward On Voltage ² | $I_S=1.6\text{A}$, $V_{\text{GS}}=0\text{V}$ | - | - | 1.2 | V |